

THIS SPEC IS OBSOLETE

Spec No: 38-06037

Spec Title: CY7C138 4K X 8/9 DUAL-PORT STATIC RAM WITH SEM

, INT, BUSY

Sunset Owner: Adithi Perepu

Replaced by: NONE



4K x 8/9 Dual-Port Static RAM with Sem, Int, Busy

Features

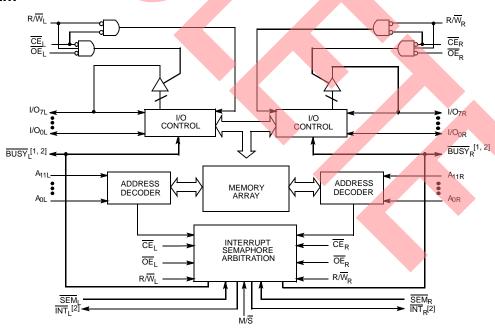
- True dual-ported memory cells that enable simultaneous reads of the same memory location
- 4K x 8 organization (CY7C138)
- 0.65-micron complementary metal oxide semiconductor (CMOS) for optimum speed and power
- High speed access: 25 ns
- Low operating power: I_{CC} = 160 mA (max.)
- Fully asynchronous operation
- Automatic power-down
- Transistor transistor logic (TTL) compatible
- Expandable data bus to 32 bits or more using Master/Slave chip select when using more than one device
- On-chip arbitration logic
- Semaphores included to permit software handshaking between ports
- INT flag for port-to-port communication
- Available in 68-pin plastic leaded chip carrier (PLCC)
- Pb-free packages available

Logic Block Diagram

Functional Description

The CY7C138 is a high speed CMOS 4K x 8 dual-port static RAM. Various arbitration schemes are included on the CY7C138 to handle situations when multiple processors access the same piece of data. Two ports are provided permitting independent, asynchronous access for reads and writes to any location in memory. The CY7C138 can be used as a standalone 8-bit dual-port static RAM or multiple devices can be combined to function as a 16-bit or wider master/slave dual-port static RAM. An M/S pin is provided for implementing 16-bit or wider memory applications without the need for separate master and slave devices or additional discrete logic. Application areas include interprocessor/multiprocessor designs, communications status buffering, and dual-port video/graphics memory.

Each port has independent control pins: chip enable (CE), read or write enable (R/W), and output enable (OE). Two flags are provided on each port (BUSY and INT). BUSY signals that the port is trying to access the same location currently being accessed by the other port. The interrupt flag (INT) permits communication between ports or systems by means of a mail box. The semaphores are used to pass a flag, or token, from one port to the other to indicate that a shared resource is in use. The semaphore logic is comprised of eight shared latches. Only one side can control the latch (semaphore) at any time. Control of a semaphore indicates that a shared resource is in use. An automatic power-down feature is controlled independently on each port by a chip enable (CE) pin or SEM pin.



Notes

- 1. BUSY is an output in master mode and an input in slave mode.
- 2. Interrupt: push-pull output and requires no pull-up resistor.



Contents

Maximum Ratings 4 Operating Range 2 Electrical Characteristics 2 Capacitance 5 Switching Characteristics 2 Architecture 12 Functional Description 12 Write Operation 12 Read Operation 12 Interrupts 14 Busy 14 Master/Slave 14	Pin Configurations	
Operating Range 4 Electrical Characteristics 4 Capacitance 5 Switching Characteristics 5 Architecture 14 Functional Description 14 Write Operation 12 Read Operation 12 Interrupts 14 Busy 14		
Electrical Characteristics 4 Capacitance 5 Switching Characteristics 5 Architecture 14 Functional Description 14 Write Operation 12 Read Operation 12 Interrupts 12 Busy 14	<u> </u>	
Capacitance 5 Switching Characteristics 5 Architecture 14 Functional Description 14 Write Operation 12 Read Operation 12 Interrupts 12 Busy 14		
Switching Characteristics 5 Architecture 12 Functional Description 14 Write Operation 12 Read Operation 14 Interrupts 12 Busy 14		
Architecture 14 Functional Description 14 Write Operation 14 Read Operation 14 Interrupts 12 Busy 14		
Write Operation		
Write Operation	Functional Description	14
Read Operation		
Interrupts14 Busy12		
Busy14		

Semaphore Operation	14
Ordering Information	17
4K x8 Dual-Port SRAM	17
Ordering Code Definition	17
Package Diagram	18
Acronyms	19
Document Conventions	
Units of Measure	19
Document History Page	20
Sales, Solutions, and Legal Information	
Worldwide Sales and Design Support	
Products	
PSoC Solutions	



Pin Configurations

Figure 1. 68-Pin PLCC (Top View)

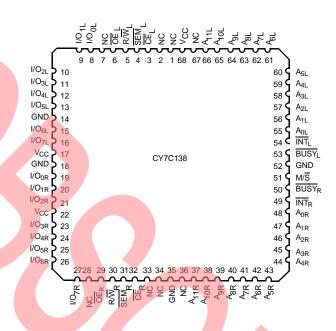


Table 1. Pin Definitions

Left Port	Right Port	Description
I/O _{0L-7L}	I/O _{0R-7R}	Data bus input/output
A _{0L-11L}	A _{0R-11R}	Address lines
CEL	CE _R	Chip enable
OE _L	OE _R	Output enable
R/W _L	R/W _R	Read/Write enable
SEM _L	SEM _R	Semaphore enable. When asserted LOW, allows access to eight semaphores. The three least significant bits of the address lines will determine which semaphore to write or read. The I/O ₀ pin is used when writing to a semaphore. Semaphores are requested by writing a 0 into the respective location.
INT _L	INT _R	Interrupt flag. INT _L is set when right port writes location FFE and is cleared when left port reads location FFE. INT _R is set when left port writes location FFF and is cleared when right port reads location FFF.
BUSY _L	BUSY _R	Busy flag
M/S		Master or slave select
V _{CC}		Power
GND		Ground

Table 2. Selection Guide

Description	7C138-25	Unit	
Maximum access time (ns)		25	ns
Maximum operating current	Commercial	180	mA
Maximum standby current for I _{SB1}	Commercial	40	mA



Maximum Ratings

Exceeding maximum ratings may impair the useful life of the device. These user guidelines are not tested. [3] Storage temperature-65 °C to +150 °C Ambient temperature with power applied –55 °C to +125 °C Supply voltage to ground potential-0.5 V to +7.0 V DC voltage applied to outputs in High Z state–0.5 V to +7.0 V DC input voltage^[4].....-0.5 V to +7.0 V Output current into outputs (LOW)20 mA

Static discharge voltage	>2001 V
(per MIL-STD-883, Method 3015)	
Latch-up current	>200 mA

Operating Range

Range	Range Ambient Temperature				
Commercial	0 °C to +70 °C	5 V ± 10%			
Industrial	–40 °C to +85 °C	5 V ± 10%			

Electrical Characteristics Over the Operating Range

Barranatan	Describition		7C13	7C138-25		
Parameter	Description	Test Condi	itions	Min	Max	Unit
V _{OH}	Output HIGH voltage	$V_{CC} = Min., I_{OH} = -4.0 \text{ mA}$	$V_{CC} = Min.$, $I_{OH} = -4.0 \text{ mA}$			
V _{OL}	Output LOW voltage	V _{CC} = Min., I _{OL} = 4.0 mA		_	0.4	V
V _{IH}				2.2	_	V
V _{IL}	Input LOW voltage			_	0.8	V
I _{IX}	Input leakage current	$GND \leq V_1 \leq V_{CC}$		-10	+10	μА
I _{OZ}	Output leakage current	Output disabled, GND ≤ VO	≤V _{CC}	-10	+10	μΑ
I _{CC}	Operating current	V _{CC} = Max.,	Commercial	_	180	mA
		I _{OUT} = 0 mA, Outputs disabled	Industrial	_	190	
I _{SB1}	Standby current	CE_L and $CE_R \ge V_{IH}$, $f = f_{MAX}^{[5]}$	Commercial	_	40	mA
	(Both ports TTL levels)		Industrial	_	50	
I _{SB2}	Standby current	\overline{CE}_L and $\overline{CE}_R \ge V_{IH}$, $f = f_{MAX}^{[5]}$	Commercial	_	110	mA
	(One port TTL level)	$f = f_{MAX}^{[S]}$	Industrial	_	120	
I _{SB3}	Standby current	Both ports	Commercial	_	15	mA
	(Both ports CMOS levels)	$\overline{\text{CE}}$ and $\overline{\text{CE}}_{\text{R}} \ge V_{\text{CC}} - 0.2 \text{ V}$, $V_{\text{IN}} \ge V_{\text{CC}} - 0.2 \text{ V}$	Industrial		30	
		or $V_{IN} \le 0.2 \text{ V, f} = 0^{[5]}$				
I _{SB4}	Standby current	One port	Commercial	-	100	mA
	(One port CMOS level)	\overline{CE}_L or $\overline{CE}_R \ge V_{CC} - 0.2 \text{ V}$, $V_{IN} > V_{CC} - 0.2 \text{ V}$ or	Industrial	-	115	
		$V_{\text{IN}} \ge V_{\text{CC}} - 0.2 \text{ V or}$ $V_{\text{IN}} \le 0.2 \text{ V, Active}$ Port outputs, $f = f_{\text{MAX}}^{[5]}$				

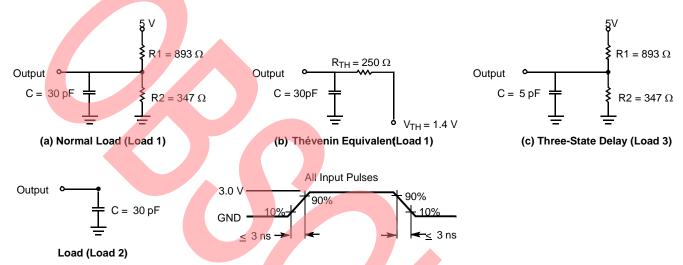
- Notes
 3. The Voltage on any input or I/O pin cannot exceed the power pin during power-up.
 4. Pulse width < 20 ns.
- 5. f_{MAX} = 1/t_{RC} = All inputs cycling at f = 1/t_{RC} (except output enable). f = 0 means no address or control lines change. This applies only to inputs at CMOS level standby I_{SB3}



Capacitance^[6]

Parameter	Description	Test Conditions	Max	Unit
C _{IN}	Input capacitance	$T_A = 25 ^{\circ}\text{C}, f = 1 \text{MHz},$	10	pF
C _{OUT}	Output capacitance	$V_{CC} = 5.0 \text{ V}$	15	pF

Figure 2. AC Test Loads and Waveforms



Switching Characteristics Over the Operating Rangel^{7]}

Parameter	Description	7C1	138-25	Unit	
Faranteter	Description	Min	Max	Ollit	
READ CYCLE					
t _{RC}	Read cycle time	25	_	ns	
t _{AA}	Address to data valid	-	25	ns	
t _{OHA}	Output hold from address change	3	-	ns	
t _{ACE}	CE LOW to data valid	-	25	ns	
t _{DOE}	OE LOW to data valid	-	15	ns	
t _{LZOE} [8,9,10]	OE Low to Low Z	3	7	ns	
t _{HZOE} [8,9,10]	OE HIGH to High Z	/-	15	ns	
t _{LZCE} [8,9,10]	CE LOW to Low Z	3	_	ns	
t _{HZCE} ^[8,9,10]	CE HIGH to High Z	-	15	ns	
t _{PU} ^[10]	CE LOW to Power-up	0	-	ns	
t _{PD} ^[10]	CE HIGH to Power-down	-	25	ns	
WRITE CYCLE					
t _{WC}	Write cycle time	25	_	ns	
t _{SCE}	CE LOW to write end	20	_	ns	

- Tested initially and after any design or process changes that may affect these parameters.
- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5 V, input pulse levels of 0 to 3.0 V, and output loading of the specified I_{OI}/I_{OH} and 30-pF load capacitance.
- At any temperature and voltage condition for any device, t_{HZCE} is less than t_{LZCE} and t_{HZOE} is less than t_{LZOE} . Test conditions used are Load 3
- 10. This parameter is guaranteed but not tested.



Switching Characteristics Over the Operating Range^[7] (continued)

Davamatar	Description	7C1	138-25	l lmi4	
Parameter	Description	Min	Max	Unit	
t _{AW}	Address setup to write end	20	_	ns	
t _{HA}	Address hold from write end	2	_	ns	
t _{SA}	Address setup to write start	0	-	ns	
t _{PWE}	Write pulse width	20	-	ns	
t _{SD}	Data setup to write end	15	_	ns	
t _{HD}	Data hold from write end	0	_	ns	
t _{HZWE} ^[11,12]	R/W LOW to High Z	_	15	ns	
t _{LZWE} [11,12]	R/W HIGH to Low Z	3	-	ns	
t _{WDD} ^[13]	Write pulse to data delay	_	50	ns	
t _{DDD} ^[13]	Write data valid to read data valid	_	30	ns	
BUSY TIMING ^[14]					
t _{BLA}	BUSY LOW from address match	_	20	ns	
t _{BHA}	BUSY HIGH from address mismatch	_	20	ns	
t _{BLC}	BUSY LOW from CE LOW	_	20	ns	
t _{BHC}	BUSY HIGH from CE HIGH	_	20	ns	
t _{PS}	Port setup for priority	5	_	ns	
t _{WB}	R/W LOW after BUSY LOW	0	_	ns	
t _{WH}	R/W HIGH after BUSY HIGH	20	_	ns	
t _{BDD} ^[15]	BUSY HIGH to data valid	-	Note 15	ns	
INTERRUPT TIMING	14]				
t _{INS}	INT set time	-	25	ns	
t _{INR}	INT reset time	-	25	ns	
SEMAPHORE TIMING	G				
t _{SOP}	SEM flag update pulse (OE or SEM)	10	-	ns	
t _{SWRD}	SEM flag write to read time	5	_	ns	
t _{SPS}	SEM flag contention window	5		ns	

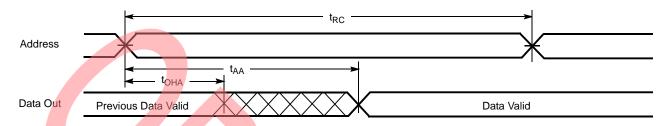
Notes

- 11. Test conditions used are Load 3.
- 12. This parameter is guaranteed but not tested.
- 13. For information on part-to-part delay through RAM cells from writing port to reading port, refer to Read Timing with Port-to-Port Delay waveform.
- 14. Test conditions used are Load 2.
- 15. t_{BDD} is a calculated parameter and is the greater of $t_{WDD} t_{PWE}$ (actual) or $t_{DDD} t_{SD}$ (actual).



Switching Waveforms

Figure 3. Read Cycle No. 1 (Either Port Address Access)[16, 17]



Notes ______
16. R/W is HIGH for read cycle.
17. Device is continuously selected CE = LOW and OE = LOW. This waveform cannot be used for semaphore reads



Figure 4. Read Cycle No. 2 (Either Port CE/OE Access)^[18, 19, 20, 21]

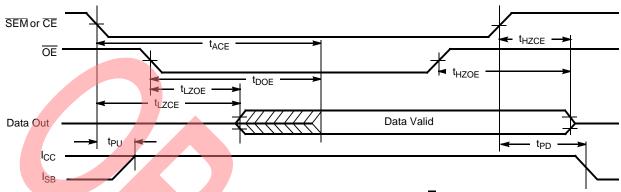
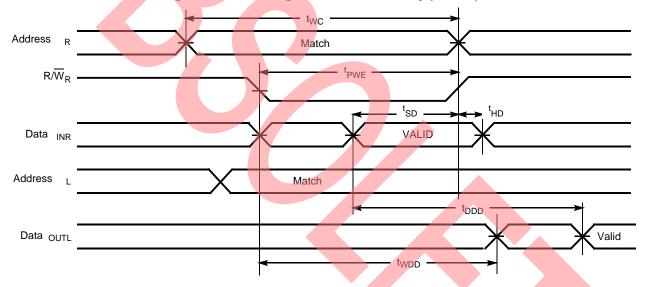


Figure 5. Read Timing with Port-to-Port Delay $(M/\overline{S} = L)^{[22, 23]}$



^{18.} R/W is HIGH for read cycle.

^{19.} Device is continuously selected \overline{CE} = LOW and \overline{OE} = LOW. This waveform cannot be used for semaphore reads.

^{20.} Address valid prior to or coincident with CE transition LOW.

21. CE_L = L, SEM = H when accessing RAM. CE = H, SEM = L when accessing semaphores.

22. BUSY = HIGH for the writing port.

23. CE_L = CE_R = LOW.



Figure 6. Write Cycle No. 1: OE Three-States Data I/Os (Either Port)[24, 25, 26]

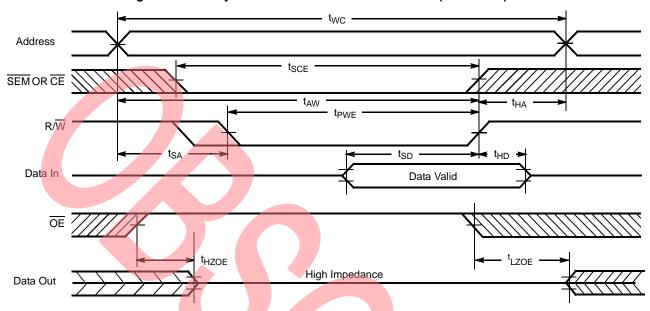
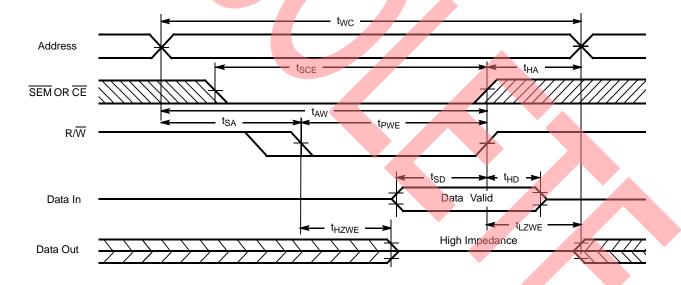


Figure 7. Write Cycle No. 2: R/W Three-States Data I/Os (Either Port)[24, 26, 27]



Notes

^{24.} The internal write time of the memory is defined by the overlap of CE or SEM LOW and R/W LOW. Both signals must be LOW to initiate a write, and either signal can terminate a write by going HIGH. The data input setup and hold timing should be referenced to the rising edge of the signal that terminates the write.

25. If OE is LOW during a R/W controlled write cycle, the write pulse width must be the larger of t_{PWE} or (t_{HZWE} + t_{SD}) to allow the I/O drivers to turn off and data to be placed on the bus for the required t_{SD}. If OE is HIGH during a R/W controlled write cycle (as in this example), this requirement does not apply and the write pulse can be as short as the specified t_{PWE}.

26. R/W must be HIGH during all address transitions.

27. Data I/O pins enter high impedance when OE is held LOW during write.



Figure 8. Semaphore Read After Write Timing, Either Side^[28]

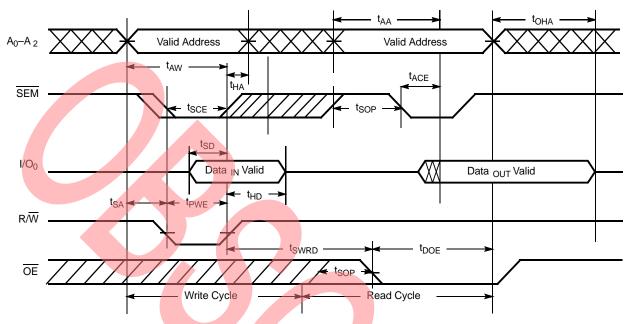
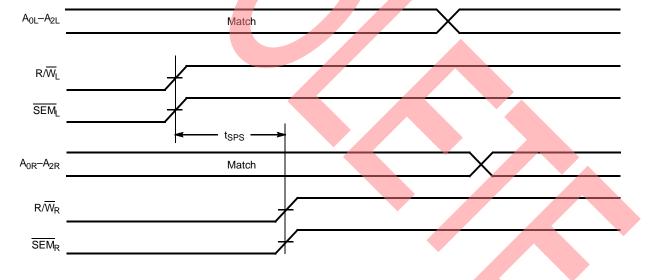


Figure 9. Timing Diagram of Semaphore Contention^[29, 30, 31]



^{28.} CE = HIGH for the duration of the above timing (both write and read cycle).

^{29.} $I/O_{0R} = I/O_{0L} = LOW$ (request semaphore); $\overline{CE}_R = \overline{CE}_L = HIGH$

^{30.} Semaphores are reset (available to both ports) at cycle start.
31. If t_{SPS} is violated, the semaphore will definitely be obtained by one side or the other, but there is no guarantee which side will control the semaphore.



Figure 10. Timing Diagram of Read with $\overline{\rm BUSY}$ (M/ $\overline{\rm S}$ = HIGH)[32]

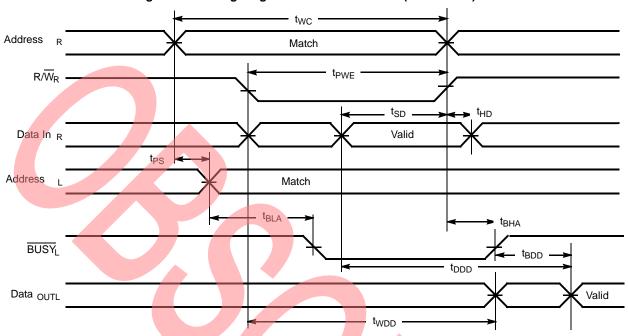


Figure 11. Write Timing with Busy Input (M/S=LOW)

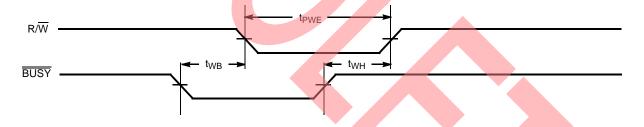




Figure 12. Busy Timing Diagram No. 1 ($\overline{\text{CE}}$ Arbitration)[33]

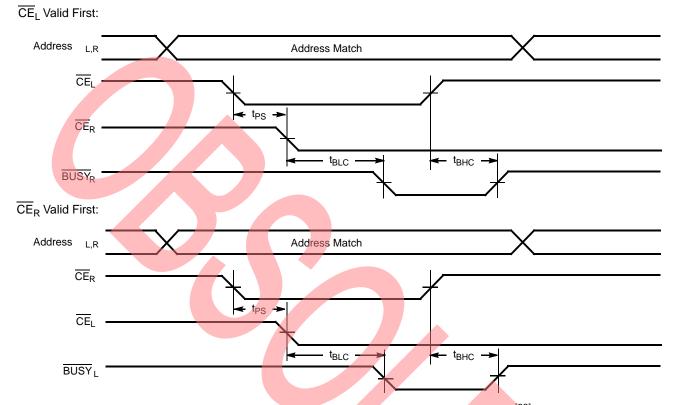
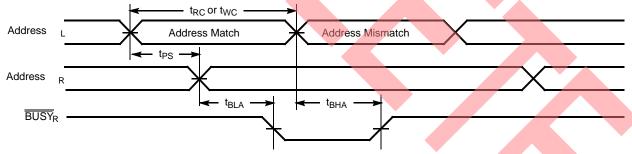
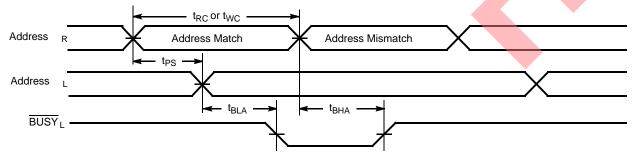


Figure 13. Busy Timing Diagram No. 2 (Address Arbitration)[33]

Left Address Valid First:



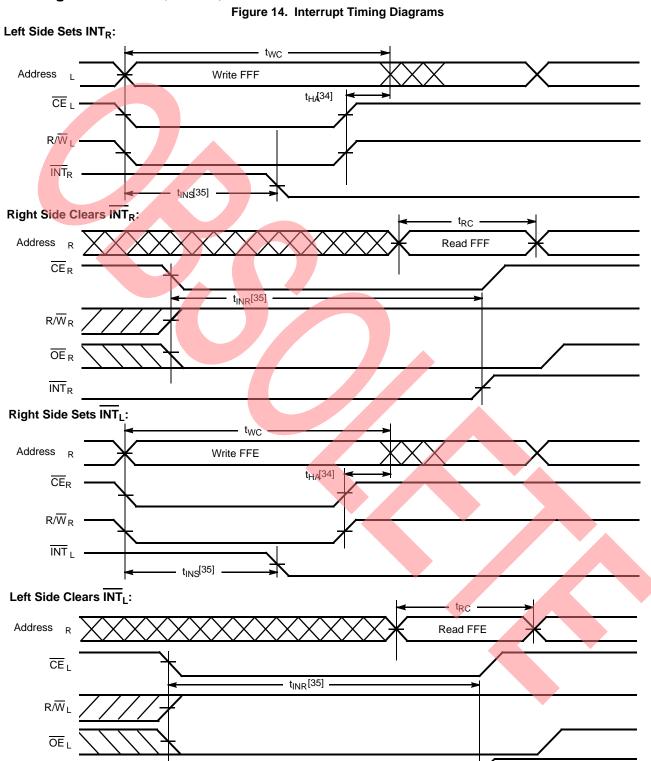
Right Address Valid First:



Note

33. If t_{PS} is violated, the busy signal will be asserted on one side or the other, but there is no guarantee on which side BUSY will be asserted.





^{34.} t_{HA} depends on which enable pin $(\overline{CE}_L \text{ or } \overline{R/W}_L)$ is deasserted first. 35. t_{INS} or t_{INR} depends on which enable pin $(\overline{CE}_L \text{ or } \overline{R/W}_L)$ is asserted last.



Architecture

The CY7C138 consists of an array of 4K words of 8 bits each of dual-port RAM cells, I/O and address lines, and control signals (CE, OE, R/W). These control pins permit independent access for reads or writes to any location in memory. To handle simultaneous writes and reads to the same location, a BUSY pin is provided on each port. Two interrupt (INT) pins can be used for port-to-port communication. Two semaphore (SEM) control pins are used for allocating shared resources. With the M/S pin, the CY7C138 can function as a master (BUSY pins are outputs) or as a slave (BUSY pins are inputs). The CY7C138 has an automatic power-down feature controlled by CE. Each port is provided with its own output enable control (OE), which enables data to be read from the device.

Functional Description

Write Operation

Data <u>m</u>ust be set up for a duration of t_{SD} before the rising edge of R/W in order to guarantee a valid write. A write operation is controlled by either the OE pin (see Write Cycle No. 1 waveform) or the R/W pin (see Write Cycle No. 2 waveform). Data can be written to the device t_{HZOE} after the OE is deasserted or t_{HZWE} after the falling edge of R/W. Required inputs for non-contention operations are summarized in Table 3.

If a location is being written to by one port and the opposite port attempts to read that location, a port-to-port flowthrough delay must be met before the data is read on the output; otherwise the data read is not deterministic. Data is valid on the port t_{DDD} after the data is presented on the other port.

Read Operation

When reading the device, the user must assert both the OE and CE pins. Data is available t_{ACE} after CE or t_{DOE} after OE is asserted. If the user of the CY7C138 wishes to access a semaphore flag, then the SEM pin must be asserted instead of the CE pin.

Interrupts

The interrupt flag ($\overline{\text{INT}}$) permits communications between ports. When the left port writes to location FFF, the right port's interrupt flag ($\overline{\text{INT}}_R$) is set. This flag is cleared when the right port reads that same location. Setting the left port's interrupt flag ($\overline{\text{INT}}_L$) is accomplished when the right port writes to location FFE. This flag is cleared when the left port reads location FFE. The message at FFF or FFE is user-defined. See Table 4 for input requirements for $\overline{\text{INT}}_R$ and $\overline{\text{INT}}_L$ are push-pull outputs and do not require pull-up resistors to operate. $\overline{\text{BUSY}}_L$ and $\overline{\text{BUSY}}_R$ in master mode are push-pull outputs and do not require pull-up resistors to operate.

Busy

The CY7C138 provides on-chip arbitration to alleviate simultaneous memory location access (contention). If both ports' CEs are asserted and an address match occurs within t_{PS} of each other the Busy logic determines which port has access. If t_{PS} is violated, one port definitely gains permission to the location, but it is not guaranteed which one. BUSY will be asserted t_{BLA} after an address match or t_{BLC} after CE is taken LOW.

Master/Slave

A M/S pin is provided to expand the word width by configuring the device as either a master or a slave. The BUSY output of the master is connected to the BUSY input of the slave. This enables the device to interface to a master device with no external components. Writing of slave devices must be delayed until after the BUSY input has settled. Otherwise, the slave chip may begin a write cycle during a contention situation. When presented as a HIGH input, the M/S pin allows the device to be used as a master and therefore the BUSY line is an output. BUSY can then be used to send the arbitration outcome to a slave.

Semaphore Operation

The CY7C138 provides eight semaphore latches, which are separate from the dual-port memory locations. Semaphores are used to reserve resources that are shared between the two ports. The state of the semaphore indicates that a resource is in use. For example, if the left port wants to request a resource, it sets a latch by writing a zero to a semaphore location. The left port then verifies its success in setting the latch by reading it. After writing to the semaphore, SEM or OE must be deasserted for t_{SOP} before attempting to read the semaphore. The semaphore value is available t_{SWRD} + t_{DOE} after the rising edge of the semaphore write. If the left port was successful (reads a zero), it assumes control over the shared resource, otherwise (reads a one) it assumes the right port has control and continues to poll the semaphore. When the right side has relinquished control of the semaphore (by writing a one), the left side succeeds in gaining control of the a semaphore. If the left side no longer requires the semaphore, a 1 is written to cancel its request.

Semaphores are accessed by asserting $\overline{\text{SEM}}$ LOW. The $\overline{\text{SEM}}$ pin functions as a chip enable for the semaphore latches ($\overline{\text{CE}}$ must remain HIGH during $\overline{\text{SEM}}$ LOW). A_{0-2} represents the semaphore address. $\overline{\text{OE}}$ and $\overline{\text{R/W}}$ are used in the same manner as a normal memory access. When writing or reading a semaphore, the other address pins have no effect.

When writing to the semaphore, only I/O_0 is used. If a zero is written to the left port of an unused semaphore, a one will appear at the same semaphore address on the right port. That semaphore can now only be modified by the side showing zero (the left port in this case). If the left port now relinquishes control by writing a one to the semaphore, the semaphore is set to 1 for both sides. However, if the right port had requested the semaphore (written a zero) while the left port had control, the right port immediately owns the semaphore after the left port releases it. Table 5 shows sample semaphore operations.

When reading a semaphore, all eight or nine data lines output the semaphore value. The read value is latched in an output register to prevent the semaphore from changing state during a write from the other port. If both ports attempt to access the semaphore within $t_{\rm SPS}$ of each other, the semaphore is definitely obtained by one side or the other, but there is no guarantee which side controls the semaphore.

Initialization of the semaphore is not automatic and must be reset during initialization program at power-up. All semaphores on both sides should have a 1 written into them at initialization from both sides to assure that they are free when needed.



Table 3. Non-Contending Read/Write

	Inpu	ıts		Outputs	Operation
CE	R/W	OE	SEM	I/O ₀₋₇	Operation
Н	Х	Х	Н	High Z	Power-down
Н	Н		L	Data out	Read data in semaphore
Х	Х	Н	Х	High Z	I/O lines disabled
Н	4	X	L	Data in	Write to semaphore
L	Н	L	Н	Data ut	Read
L	L	X	Н	Data in	Write
L	Х	X	L		Illegal condition

Table 4. Interrupt Operation Example (assumes BUSY_L=BUSY_R=HIGH)

Left Port							Right Port					
	Function		R/W	CE	OE	A ₀₋₁₁	INT	R/W	CE	OE	A ₀₋₁₁	INT
Set left INT			X	X	Х	Х	L	L	L	Х	FFE	Х
Reset left INT			X	L	_	FFE	Н	Х	Х	Х	Х	Х
Set right INT			L	L	Х	FFF	Х	Х	Х	Х	Х	L
Reset right INT			X	X	Х	Х	Х	Х	L	L	FFF	Н

Table 5. Semaphore Operation Example

Function	I/O ₀₋₇ Left	I/O ₀₋₇ Right	Status
No action	1	1	Semaphore free
Left port writes semaphore	0	1	Left port obtains semaphore
Right port writes 0 to semaphore	0	1	Right side is denied access
Left port writes 1 to semaphore	1	0	Right port is granted access to semaphore
Left port writes 0 to semaphore	1	0	No change. Left port is denied access
Right port writes 1 to semaphore	0	1	Left port obtains semaphore
Left port writes 1 to semaphore	1	1	No port accessing semaphore address
Right port writes 0 to semaphore	1	0	Right port obtains semaphore
Right port writes 1 to semaphore	1	1	No port accessing semaphore
Left port writes 0 to semaphore	0	1	Left port obtains semaphore
Left port writes 1 to semaphore	1	1	No port accessing semaphore



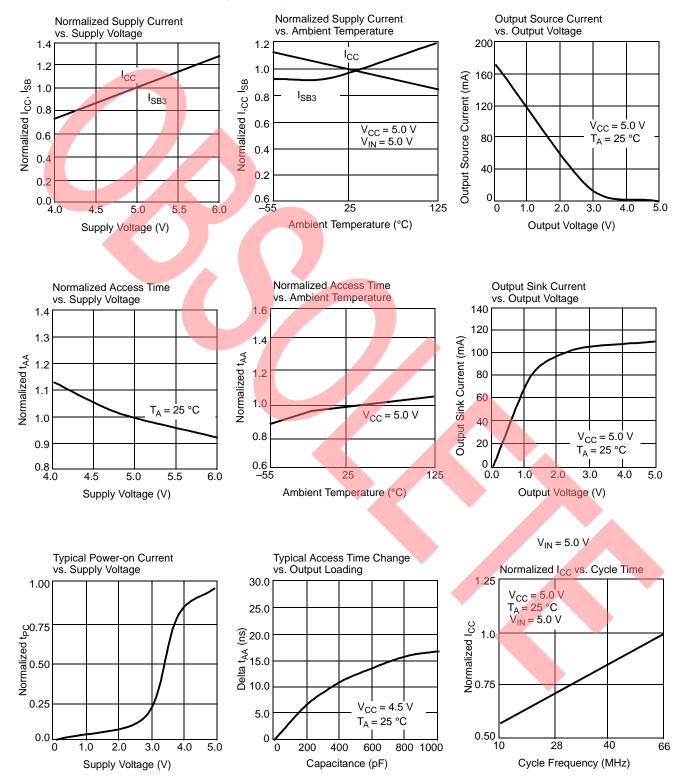


Figure 15. Typical DC and AC Characteristics

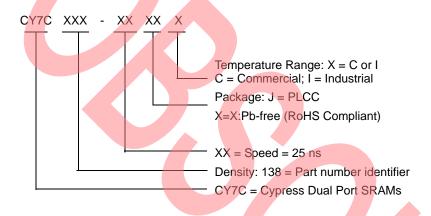


Ordering Information

4K x8 Dual-Port SRAM

Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range
25	CY7C138-25JXC	51-85005	68-Pin Plastic Leaded Chip Carrier (Pb-free)	Commercial
	CY7C138-25JXI	51-85005	68-Pin Plastic Leaded Chip Carrier (Pb-free)	Industrial

Ordering Code Definition

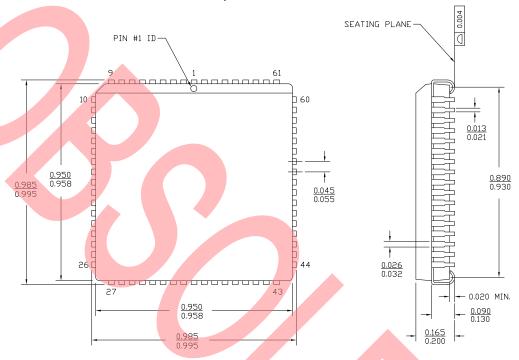




Package Diagram

Figure 16. 68-Pin Plastic Leaded Chip Carrier (51-85005)

68 Lead Plastic Leaded Chip Carrier J81



DIMENSIONS IN INCHES MIN. MAX.

51-85005 *B



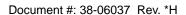
Acronyms

Acronym	Description
CMOS	complementary metal oxide semiconductor
TQFP	thin quad plastic flatpack
I/O	input/output
SRAM	static random access memory
PLCC	plastic leaded chip carrier
TTL	transistor transistor logic

Document Conventions

Units of Measure

Symbol	Unit of Measure		
ns	nano seconds		
V	Volts		
μΑ	micro Amperes		
mA	milli Amperes		
Ω	Ohms		
mV	milli Volts		
MHz	Mega Hertz		
pF	pico Farad		
W	Watts		
°C	degree Celcius		





Document History Page

Document Title: CY7C138 4K x 8/9 Dual-Port Static RAM with Sem, Int, Busy Document Number: 38-06037					
Rev.	ECN No.	Orig. of Change	Submission Date	Description of Change	
**	110180	SZV	09/29/01	Change from Spec number: 38-00536 to 38-06037	
*A	122287	RBI	12/27/02	power-up requirements added to Maximum Ratings Information	
*B	393403	YIM	See ECN	Added Pb-Free Logo Added Pb-Free parts to ordering information: CY7C138-15JXC, CY7C138-25JXC, CY7C139-25JXC	
*C	2623658	VKN/PYRS	12/17/08	Added CY7C138-25JXI part Removed CY7C139 from the Ordering information table	
*D	2672737	GNKK	03/12/2009	Corrected title in the Document History table	
*E	2714768	VKN/AESA	06/04/2009	Corrected defective Logic Block diagram, Pinouts and Package diagrams	
*F	2898564	RAME	03/24/10	Removed inactive parts. Updated package diagram.	
*G	3099184	ADMU	12/0 <mark>2/20</mark> 10	Removed information for CY7C139 parts. Removed speed bins -15,-35,-55. Updated datasheet as per new template Added Acronyms and Units of Measure table Added Ordering Code Definition Updated all footnotes.	
*H	3402051	ADMU	10/12/2011	Obsolete spec.	



Sales, Solutions, and Legal Information

Worldwide Sales and Design Support

Cypress maintains a worldwide network of offices, solution centers, manufacturer's representatives, and distributors. To find the office closest to you, visit us at cypress.com/sales.

Products

Automotive cypress.com/go/automotive cypress.com/go/clocks lnterface cypress.com/go/interface cypress.com/go/powerpsoc cypress.com/go/plc

Memory cypress.com/go/memory

Memory
Optical & Image Sensing
PSoC
Touch Sensing
USB Controllers
Wireless/RF

cypress.com/go/memory
cypress.com/go/image
cypress.com/go/psoc
cypress.com/go/touch
cypress.com/go/USB
cypress.com/go/wireless

PSoC Solutions

psoc.cypress.com/solutions PSoC 1 | PSoC 3 | PSoC 5

© Cypress Semiconductor Corporation, 2009-2011. The information contained herein is subject to change without notice. Cypress Semiconductor Corporation assumes no responsibility for the use of any circuitry other than circuitry embodied in a Cypress product. Nor does it convey or imply any license under patent or other rights. Cypress products are not warranted nor intended to be used for medical, life support, life saving, critical control or safety applications, unless pursuant to an express written agreement with Cypress. Furthermore, Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress products in life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress against all charges.

Any Source Code (software and/or firmware) is owned by Cypress Semiconductor Corporation (Cypress) and is protected by and subject to worldwide patent protection (United States and foreign), United States copyright laws and international treaty provisions. Cypress hereby grants to licensee a personal, non-exclusive, non-transferable license to copy, use, modify, create derivative works of, and compile the Cypress Source Code and derivative works for the sole purpose of creating custom software and or firmware in support of licensee product to be used only in conjunction with a Cypress integrated circuit as specified in the applicable agreement. Any reproduction, modification, translation, compilation, or representation of this Source Code except as specified above is prohibited without the express written permission of Cypress.

Disclaimer: CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS MATERIAL, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. Cypress reserves the right to make changes without further notice to the materials described herein. Cypress does not assume any liability arising out of the application or use of any product or circuit described herein. Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress' product in a life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress against all charges.

Use may be limited by and subject to the applicable Cypress software license agreement.